Docket No.

Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inventor, I hereby declare that:

My residence, Post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

COMPUTER SYSTEM WITH HOT SWAP FUNCTION

the specification of wh	nich			
(check one)				
is attached hereto.				
□ was filed on International		as Un	ited States /	Application No. or PCT
Application Number	er			
and was amended	on			
		(if applicable)		
I hereby state that I specification, including				of the above identified rred to above.
*	me to be material			nd Trademark Office all Title 37, Code of Federal
or Section 365(b) of a 365(a) of any PCT Int the United States, lis	any foreign applicaternational applicated below and had patent or inventor of the application of	ation(s) for paten tion which design ave also identifie ''s certificate or F	t or inventor' ated at least d below, by 'CT Internatio	code, Section 119(a)-(d) is certificate, or Section one country other than checking the box, any anal application having a
Filor Foreign Applicati	OH(S)			Priority Not Claimed
089119023 (Number)	R.O.C.		9/2000 h/Year Filed)	G
(Number)	(Country)	(Day/Work	ii) teal Theu)	п
(Number)	(Country)	(Day/Mont	h/Year Filed)	П
om PTO-SB-01 (9-95) (Modified)	F	P02/REV02 Patent	and Trademark Of	ffice-U.S. DEPARTMENT OF COMME

I hereby claim the benefit under application(s) listed below:	35 U.S.C Section 119(e) of any United States Provisional
(Application Serial No.)	(Filing Date	e)
(Application Serial No.)	(Filing Date	e)
(Application Serial No.)	(Filing Dat	e)
the prior United States or PCT In paragraph of 35 U.S.C. Section 11 Patent and Trademark Office all in	ternational application i 2, I acknowledge the d oformation known to m 1.56 which became ava	of this application is not disclosed in in the manner provided by the first that to disclose to the United States to be material to patentability as ailable between the filing date of the date of this application:
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

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3.22.2001

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